PNS3010T SERIES

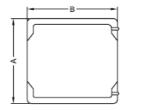
1. PART NO. EXPRESSION :

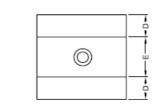
 $\frac{PNS}{(a)} \frac{3010}{(b)} \frac{T4R7M}{(c)} \frac{F}{(e)}$

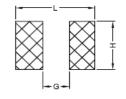
- (a) Series code
- (b) Dimension code
- (c) Material code

- (d) Inductance code : 4R7 = 4.7uH
- (e) Tolerance code : $M=\pm 20\%, Y=\pm 30\%$
- (f) F: RoHS Compliant

2. CONFIGURATION & DIMENSIONS :



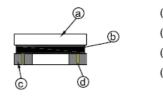




Recommended PCB Pattern

А	В	с	D	E	L	G	н
3.0±0.2	3.0±0.2	1.0 Max.	1.0 Ref.	1,0 Ref.	3,2 Ref.	1.0 Ref.	3,2 Ref.

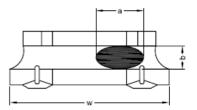
3. MATERIALS :



(a) Core(b) Coating(c) Termination(d) Wire

Void appearance tolerance Limit

Size of voids occurring to coating resin is specified below.



Appearance of exposed wire tolerance limit:

- 1, Width direction (dimension a) : Acceptable when a ${\leq}$ w/2 Nonconforming when a ${>}$ w/2
- 2. Length direction (dimension b) : Dimension b is not specified.
- The total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, and is acceptable.



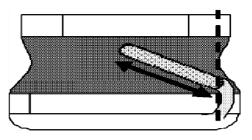
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External appearance criterion for exposed wire

Exposed end of the winding wire at the secondary side should be 2mm and below.



4. GENERAL SPECIFICATION :

- a) Isat-Based on inductance change (Δ L/L0: 30%) @ ambient temp. 25"C
- b) Irms- Based on temperature rise (Δ T:40°C) Max
- c) Operating Temperature : -40°C to 125°C
- d) Storage Condition (Component in its packaging)
 - i) Temperature: -10°C to 40°C
 - ii) Humidity: 60%

Part No.	Inductance (uH)	Test Frequency (Hz)	RDC (Ω)+20%	lsat (A) Typ.	Irms (A) Typ.
PNS3010T1R0YF	1.0±30%	0.1V/1M	0.055	1.80	2.10
PNS3010T1R5YF	1.5±30%	0.1V/1M	0.070	1.50	1.90
PNS3010T2R2MF	2.2±20%	0.1V/1M	0.090	1.30	1.70
PNS3010T3R3MF	3.3±20%	0.1V/1M	0.130	1.10	1.50
PNS3010T4R7MF	4.7±20%	0.1V/1M	0.170	0.90	1.30
PNS3010T6R8MF	6.8±20%	0.1V/1M	0.260	0.77	1.00
PNS3010T100MF	10±20%	0.1V/1M	0.350	0.63	0.80
PNS3010T150MF	15±20%	0.1V/1M	0.510	0.54	0.70
PNS3010T220MF	22±20%	0.1V/1M	0.750	0.43	0.60

5. ELECTRICAL CHARACTERISTICS :



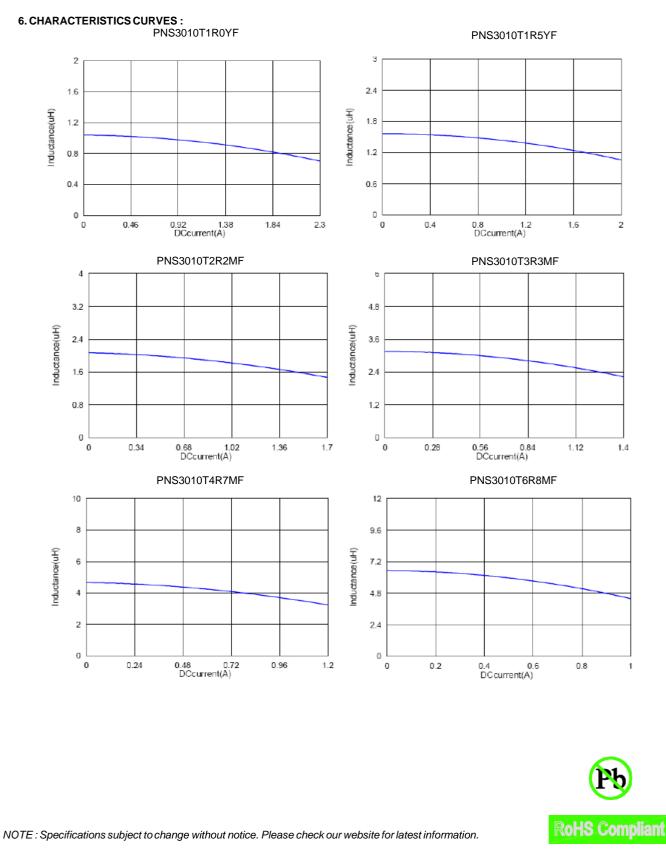
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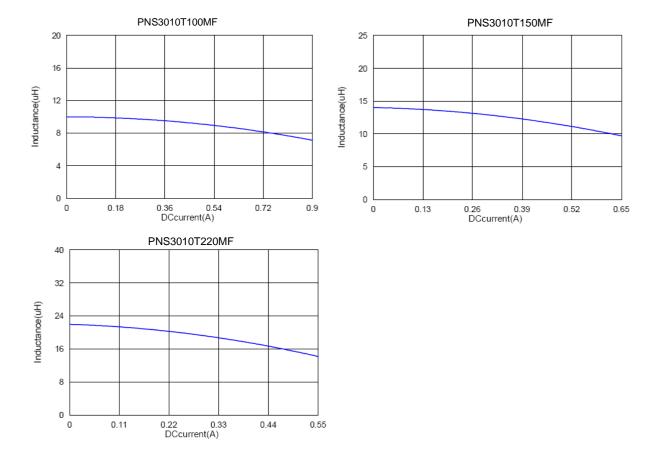
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6. CHARACTERISTICS CURVES :





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7. SOLDERING AND MOUNTING :

7-1. Soldering

PC board should be designed so that products can prevent damage from mechanical stress when warping the board Products shall be positioned in the sideway direction against the mechanical stress to prevent failure.

7-1.1 Lead Free Solder Re-flow :

Recommended temperature profiles for re-flow soldering in Figure 1.

7-1.2 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note :

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (max)

c) Never contact the ceramic with the iron tip

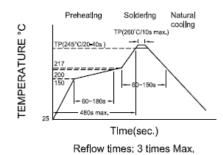
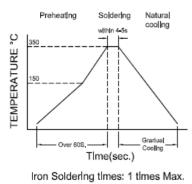


Fig.1

e) Use a 20 watt soldering iron with tip diameter of 1.0mm f) Limit soldering time to 4-5 secs,

d) 1.0mm tip diameter (max)



Flg.2



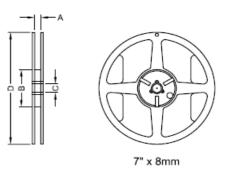
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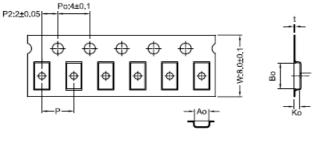
8. PACKAGING INFORMATION :

8-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7" x 8mm	8.4±1.0	50 Mln.	13 <u>+</u> 0.8	178 <u>+</u> 2

8-2 Tape Dimension / 8mm





Bottom View

Series	Ao(mm)	Bo(mm)	Ko(mm)	P(mm)	t(mm)
PNS3010T	3.2±0.05	3.2±0.05	1.20±0.2	4.0±0.05	0.23±0.05

8-3. Packaging Quantity

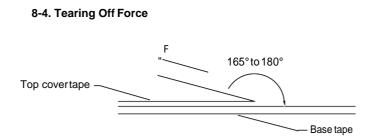
Size	PNS3010T		
Chip/Reel	2000		



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The force for tearing off cover tape is 15 to 80 grams in the *arrow* direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	(mm/min)
5-35	45-85	860-1060	

Application Notice

- 1. Storage Conditions:
 - To maintain the solderability of terminal electrodes :
 - a) Temperature and humidity conditions : Less than 40°C and 60% RH.
 - b) Recommended products should be used within 12 months from the time of delivery.
 - c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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